

# Silicon-tungsten Electromagnetic Calorimeter of ILD

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*On behalf of the ILD SiW ECAL groups*

IN2P3/CNRS

LLR (École polytechnique)

LAL (Paris Sud)

LPSC (Grenoble)

LPNHE (Paris Diderot, UPMC)

LPC (Clermont Ferrand)

Kyushu University

The University of Tokyo



東京大学  
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# Outline

Role of ECAL in International Large Detector (ILD)

Design requirements

Silicon-tungsten ECAL

Optimisation studies

Next talk (T. Frisson) will address status of detector prototypes

More details in ILC Detector Baseline Design (DBD)

# Role of ECAL and photon reconstruction in Particle Flow

Hadronic jets on average consist of

- ~65% charged particles
- ~25% photons
- ~10% neutral hadrons

Large fluctuations in these fractions

**Particle Flow (PF):** accurate jet energy measurement

PF relies on (ideally) topologically distinguishing

- Individual particle calorimeter deposits in hadronic jets
- Allows use of tracker measurements to estimate charged energy
- Main limitation: confusion between charged and neutral energy deposits
  - Double counting of energy: charged CALO energy mis-identified as neutral
  - Undercounting: neutral CALO energy mis-identified as charged

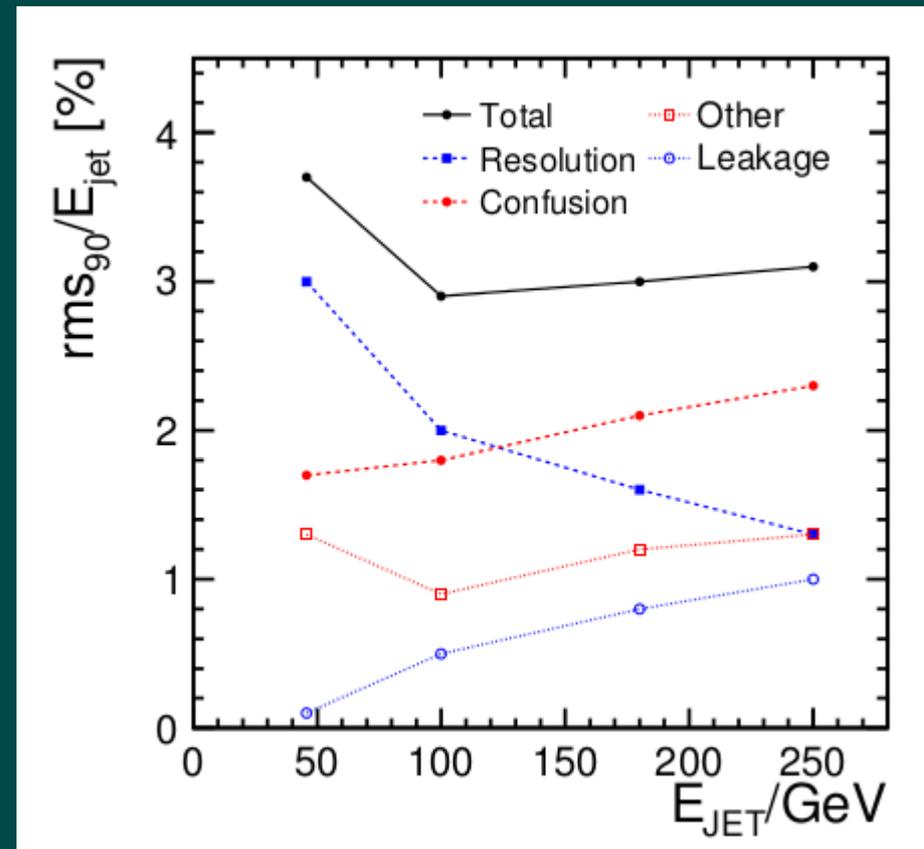
> “confusion term”

## **Main role of ECAL:**

- Cleanly identify photon energy deposits
  - Measure this photon energy reasonably well
- Identify energy deposits due to charged and neutral hadrons (with HCAL)

At lower jet energies ( $< \sim 100$  GeV),  
particles in jet generally well separated  
JER dominated by single particle energy resolution  
of photons and neutral hadrons

At higher energies ( $> \sim 100$  GeV)  
particles in jet no longer well separated  
JER dominated by confusion term  
Single particle energy resolution has  
rather small contribution



# ECAL for particle flow

Large distance IP -> ECAL:

- Allow jet to spread, increasing distance between jet particles  
easier to distinguish particles
- B-field also helps

Small Molière radius

- Smaller single particle showers  
Easier to distinguish nearby showers
- Fine segmentation of readout in 3-d  
for accurate topological clustering

$\sim 24X_0$  to contain EM showers

Compact depth: small  $X_0$

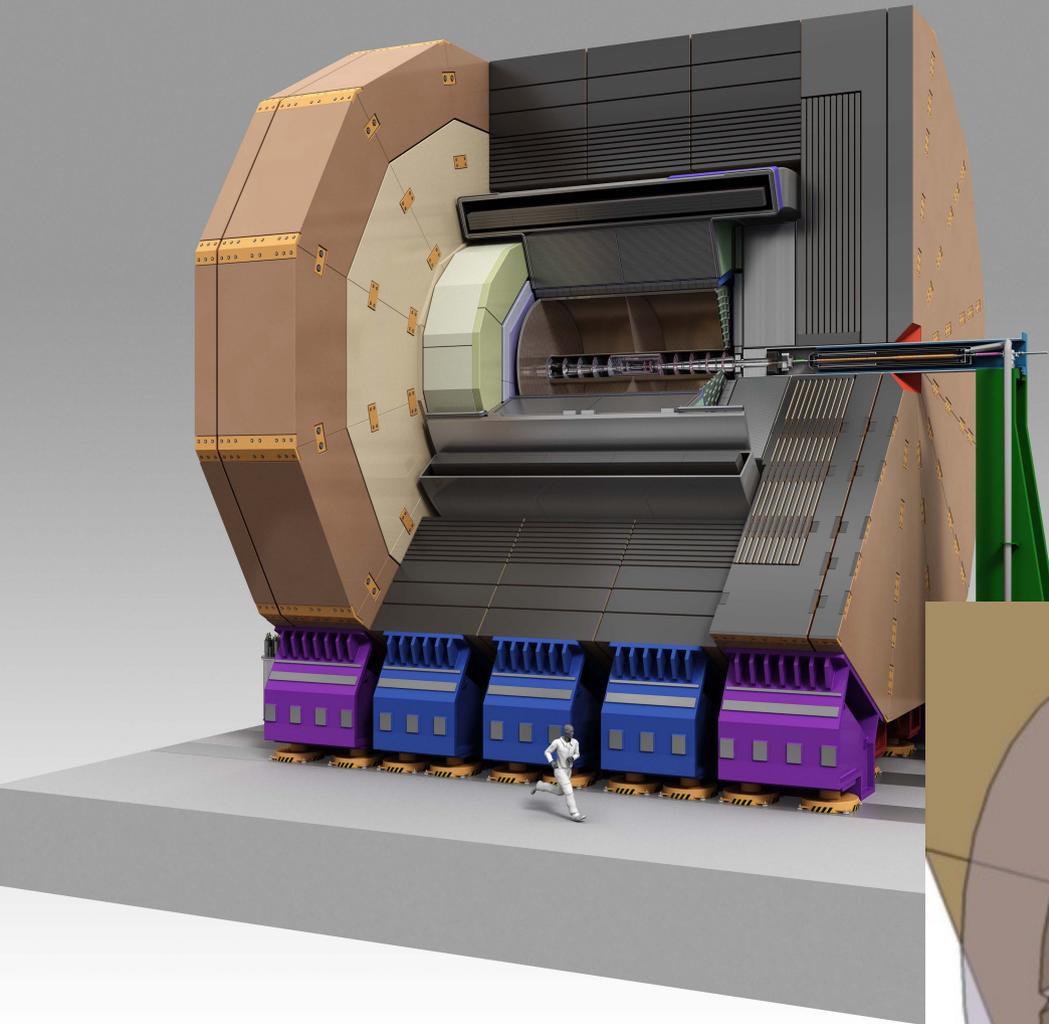
- Constrain size of detector yoke and solenoid

Relatively large hadronic interaction length

- Longitudinal separation between EM and hadronic showers

Choose multi-layer sampling calorimeter

- Tungsten is a good choice for absorber material
- In this talk, focus on silicon PIN diodes as active material  
scintillator (later talk by Sudo-san),  
hybrid (Ueno-san in simulation session)



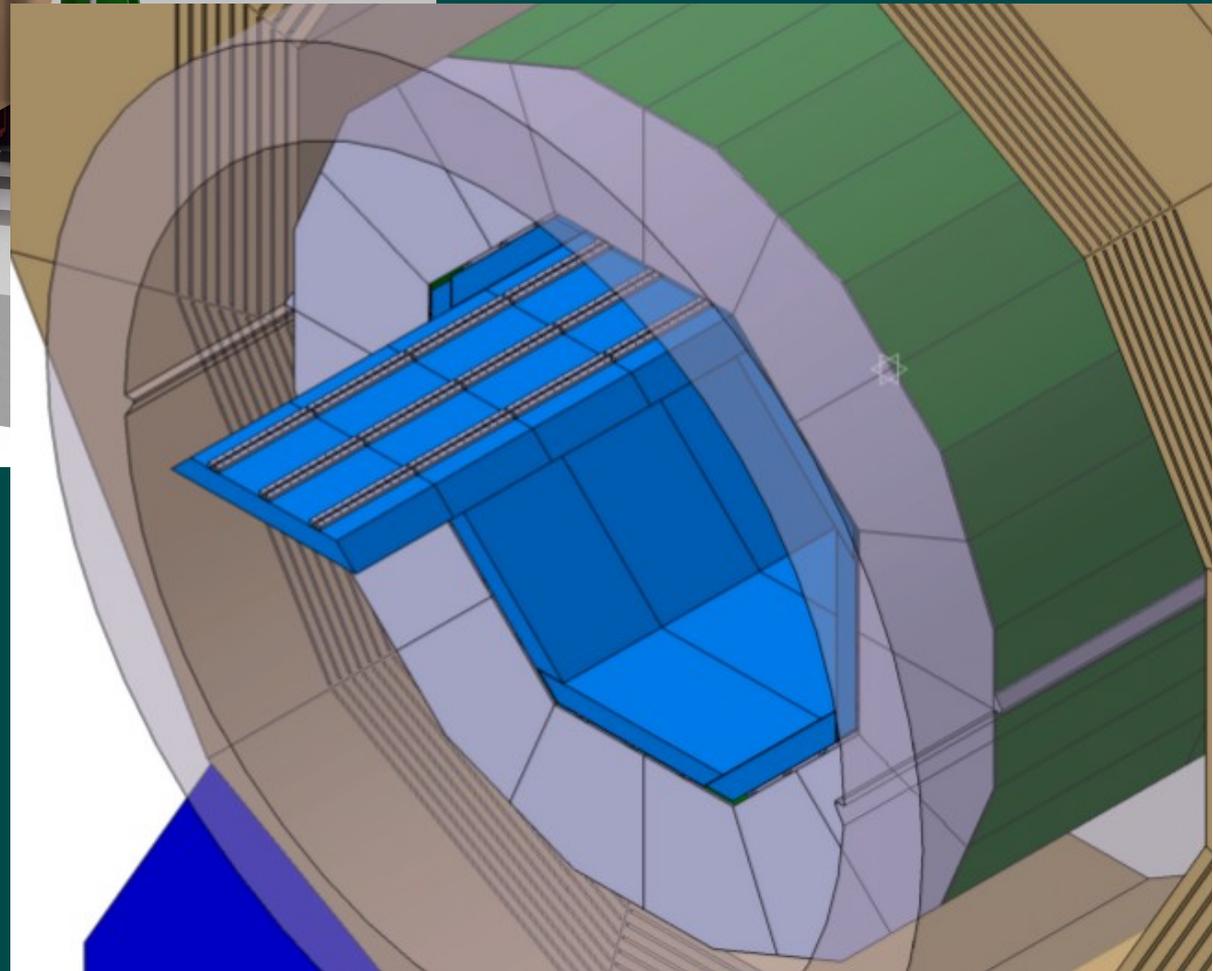
Non-projective geometry  
avoid pointing cracks

Hermiticity ECAL

ECAL ring

Forward:

LumiCal, BeamCal  
down to 5 mrad



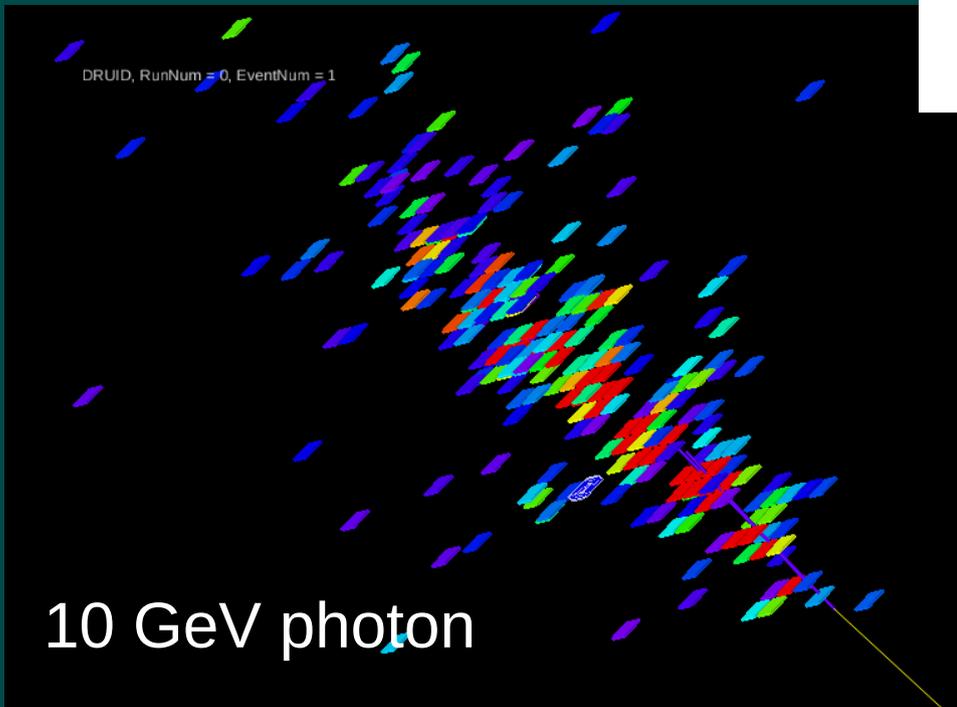
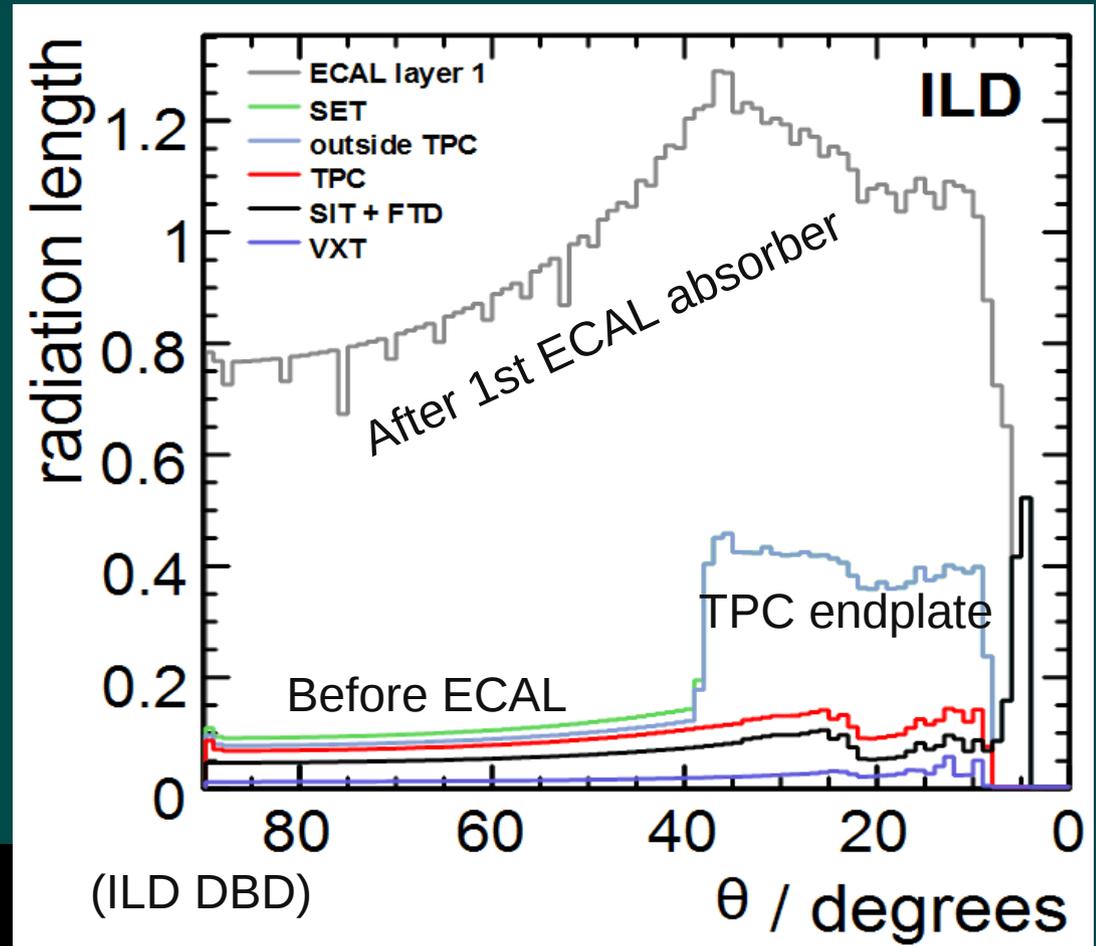
For default 30-layer design:

~2400 m<sup>2</sup> of sensors

~10<sup>8</sup> readout channels

Rather small material budget  
before ECAL

Interactions (particularly hadronic)  
before ECAL can have severe  
consequences for PF  
(~impossible to tag neutrals as  
not prompt)

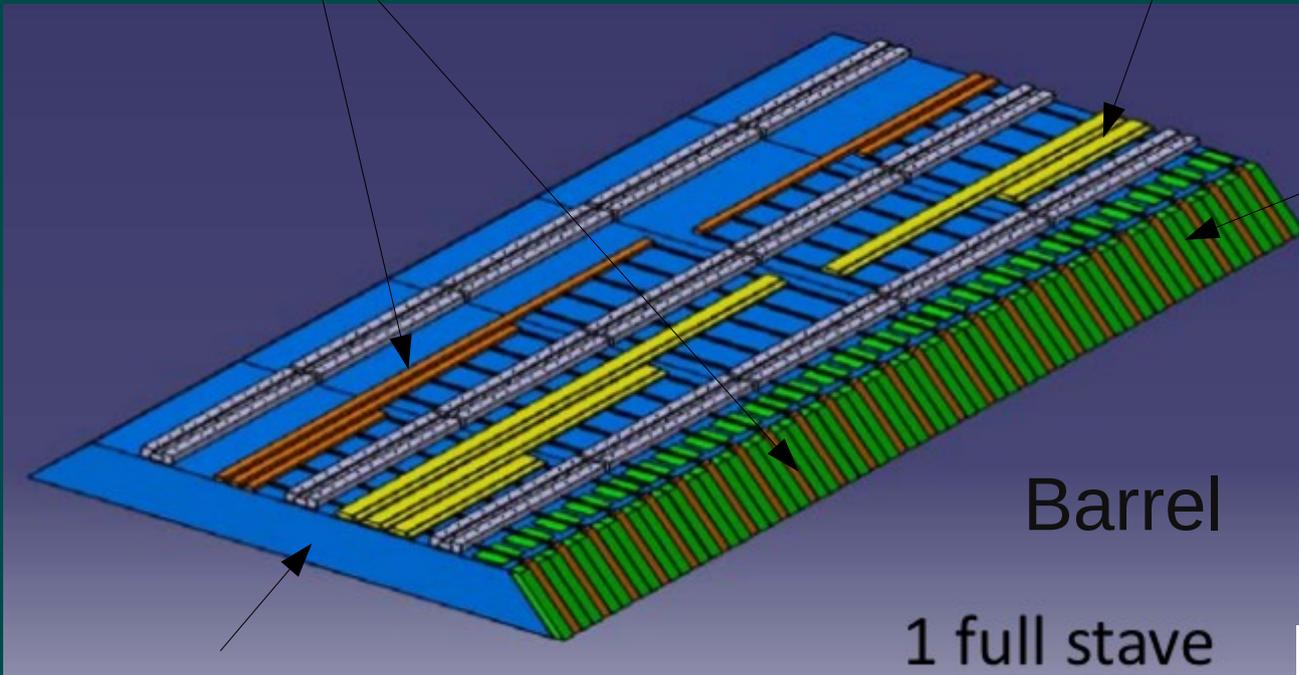


Particles typically measured by  
many detector cells

Water-based cooling

HV, LV, signal cables

DAQ interface cards



Barrel

1 full stave

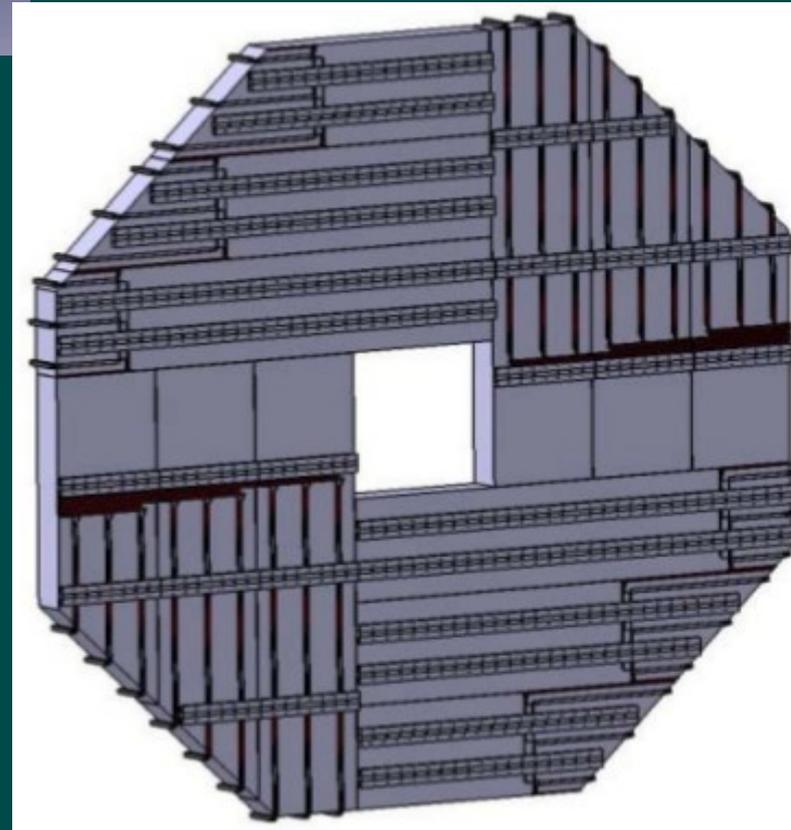
Endcap: similar design  
somewhat longer modules

Carbon-fibre / tungsten  
mechanical modules

Digitization, data concentration performed  
inside detector

Services run in 3cm gap between ECAL  
and HCAL

Exit detector between barrel and endcap



## Carbon-fibre/tungsten mechanical structure

Active Sensor Unit (1024 readout channels)

18X18 cm<sup>2</sup> PCB

16 readout ASICs

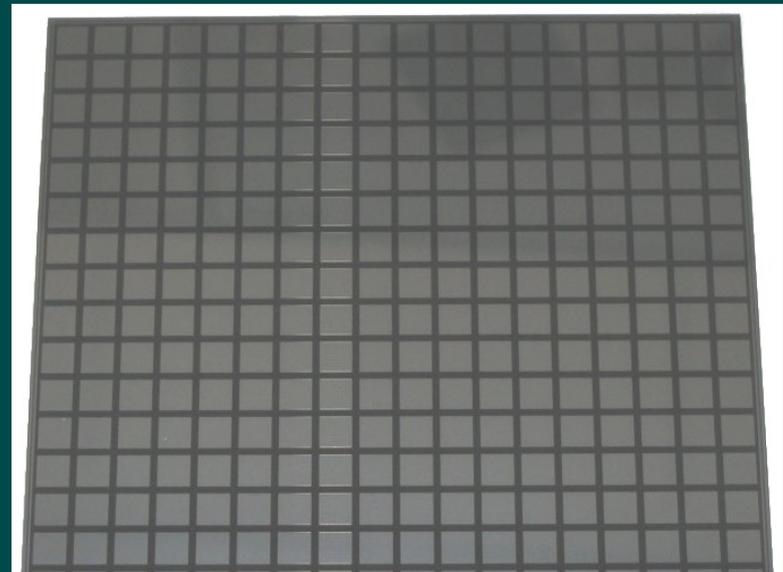
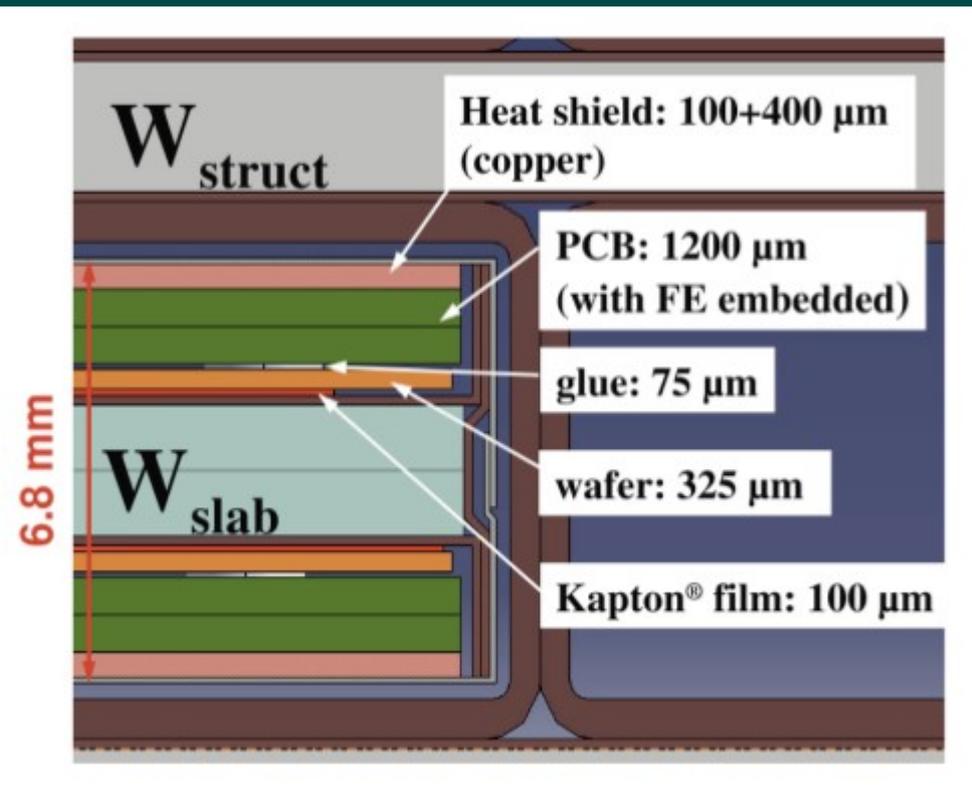
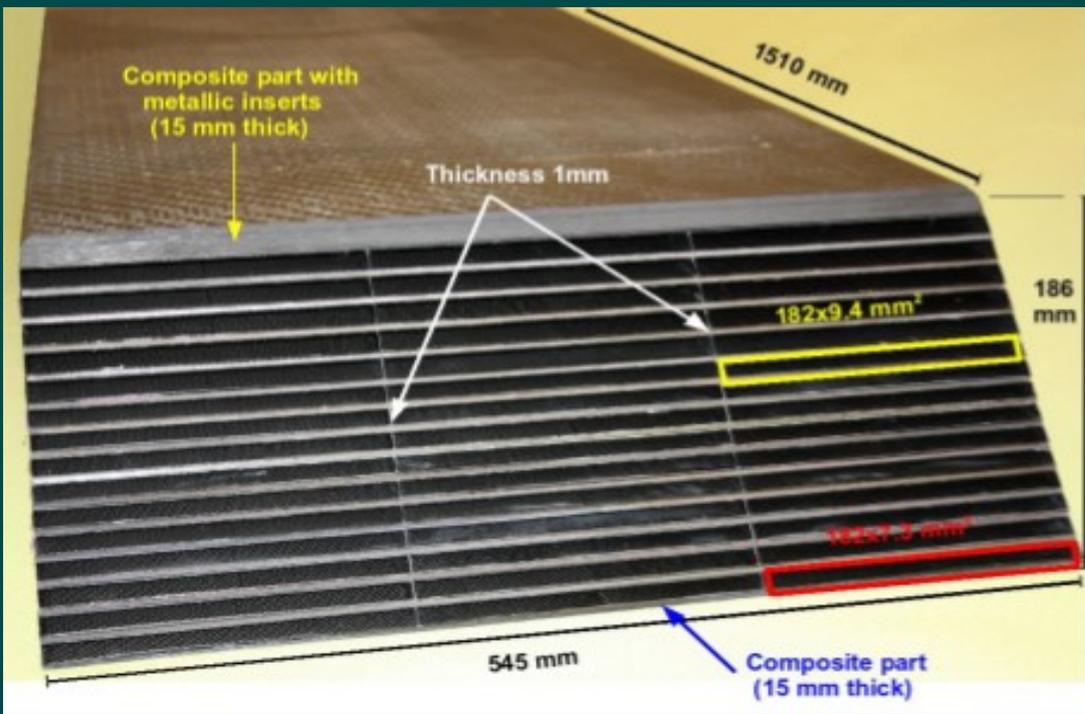
4 silicon sensors

(each with 256 5x5mm<sup>2</sup> pads)

Dynamic range: single MIP to

EM shower core @ 100s GeV

Details of technical realisation in next talk



## Power and cooling

To reduce power consumption,  
take advantage of ILC beam structure: 1ms bunch train every 200 ms  
switch off front end electronics in inter-train interval

Then ~25 microW per channel -> ~2.5kW in total within structure  
Additional power consumption in ECAL-HCAL gap (mostly DAQ)

Designed water-based cooling system  
Sub atmospheric pressure -> “leak-less”  
Remove heat at edge of every detector slab

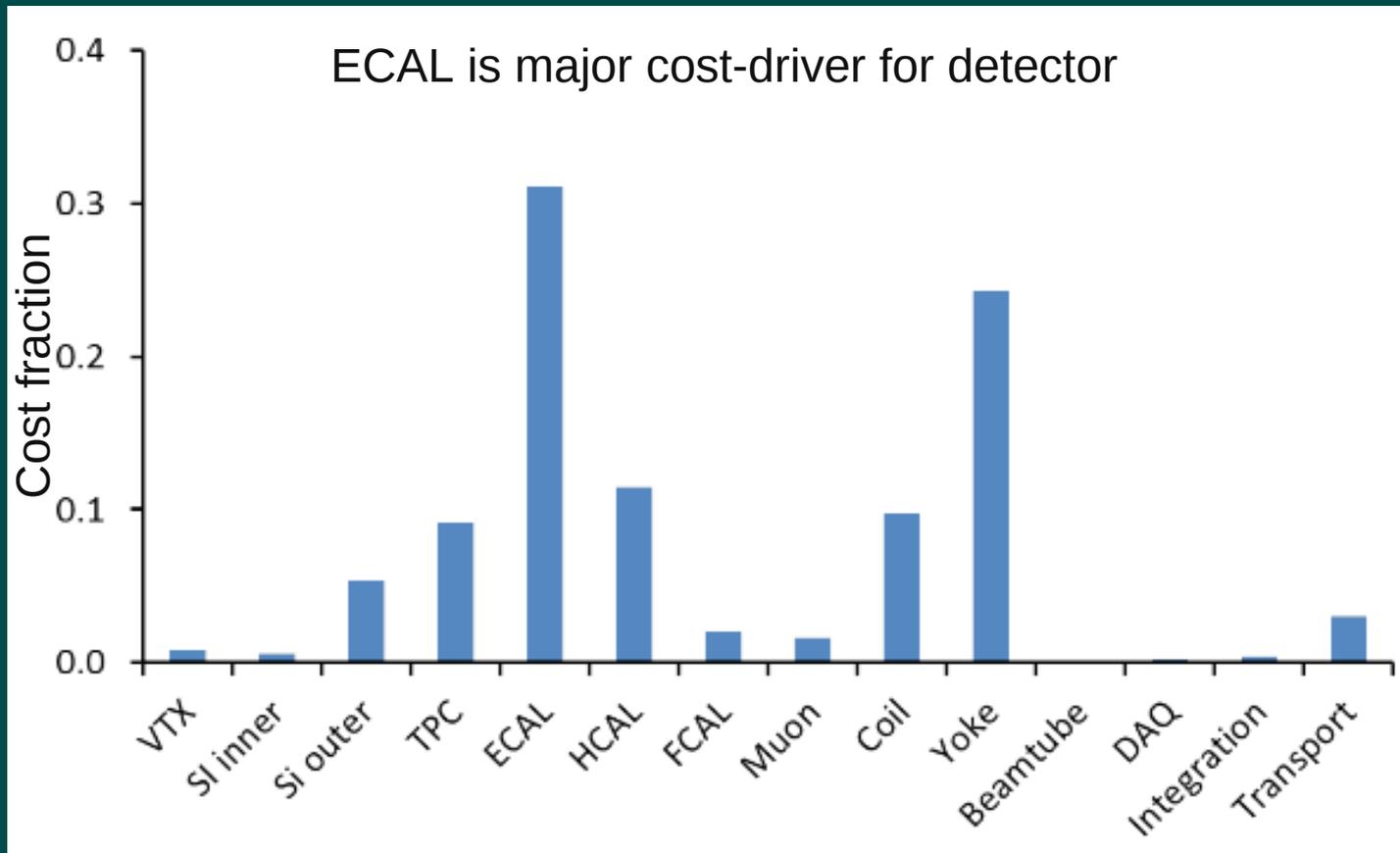
## Construction industrialisation

Highly modular design, large numbers of identical pieces  
industrialised manufacture  
Simpler testing and quality control

# Optimisation studies

to justify or reduce cost

ECAL cost driven by  
- large sensitive area  
- number of readout channels



(ILD Detector Baseline Document)

# Optimisation of ECAL

Overall dimensions

Readout granularity

Number of sampling layers

PCB thickness

Silicon sensor guard ring width

Robustness against failures

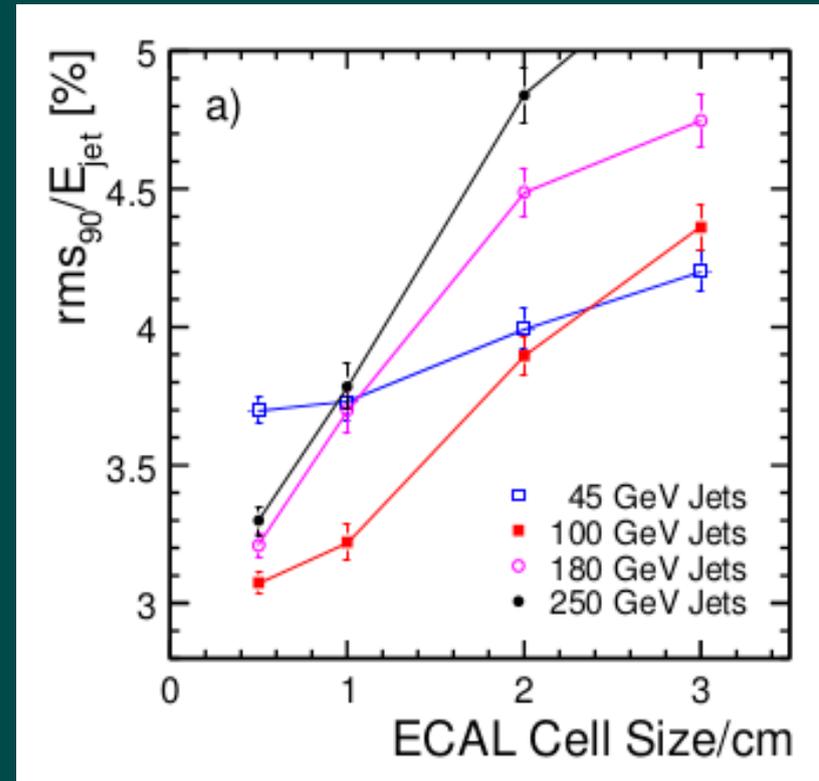
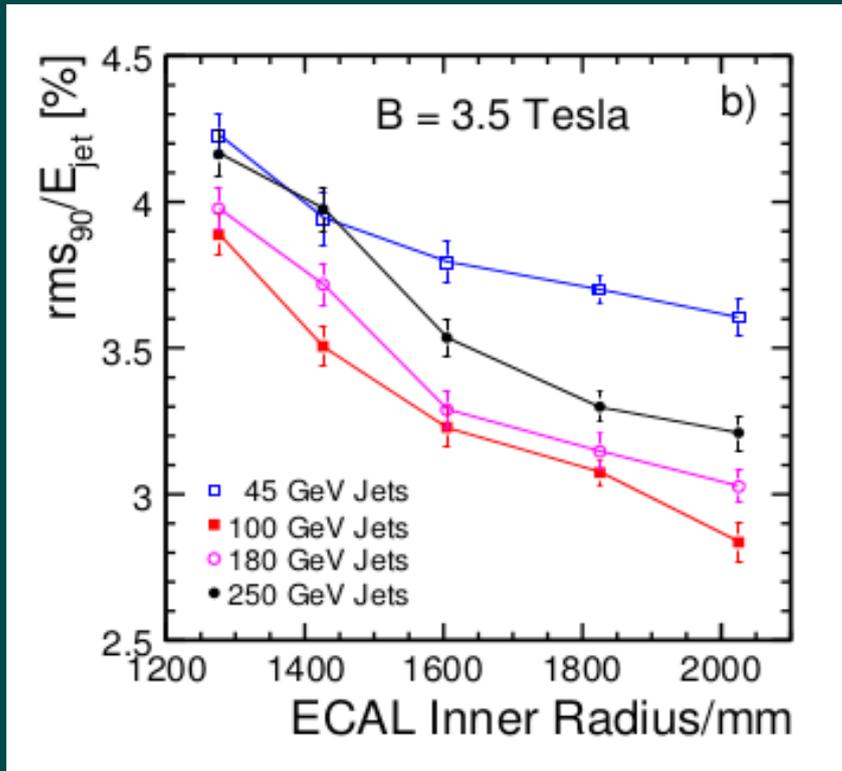
Optimisation metric:

single photon energy resolution,

PF jet energy resolution ( $\text{RMS}_{90}$ ) in 2-light quark events at various energies

Attempt to reduce cost, technical “aggressiveness”

# ECAL inner radius, readout granularity



ILD letter of Intent (2010)  
M. Thomson

Large radius clearly improves performance  
however also has large influence on cost of HCAL, solenoid and yoke

Cell sizes below 1cm useful for higher energy (>100 GeV) jets  
(higher particle density in higher energy jets)

# Number of sampling layers

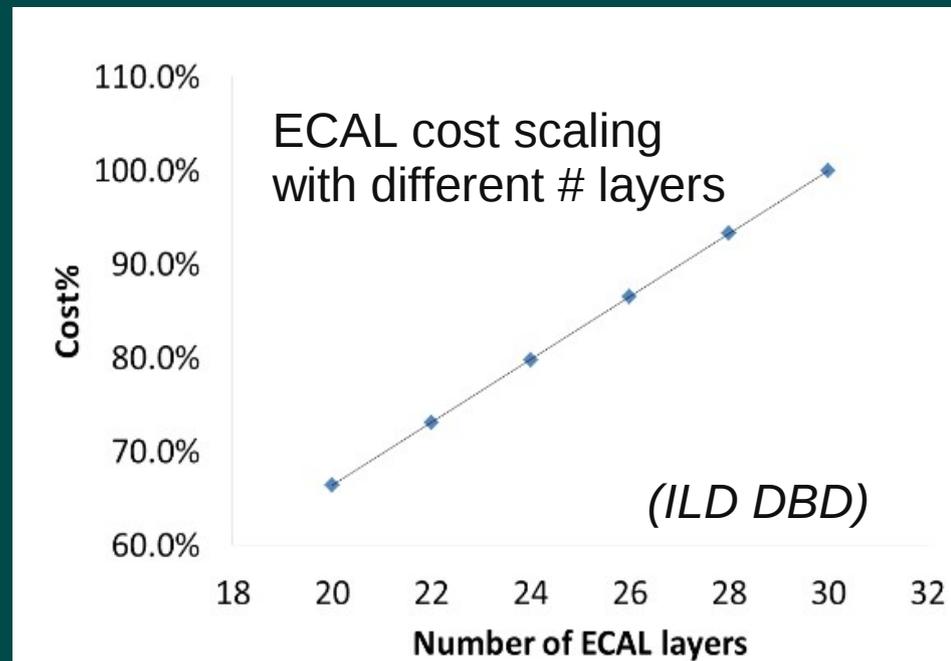
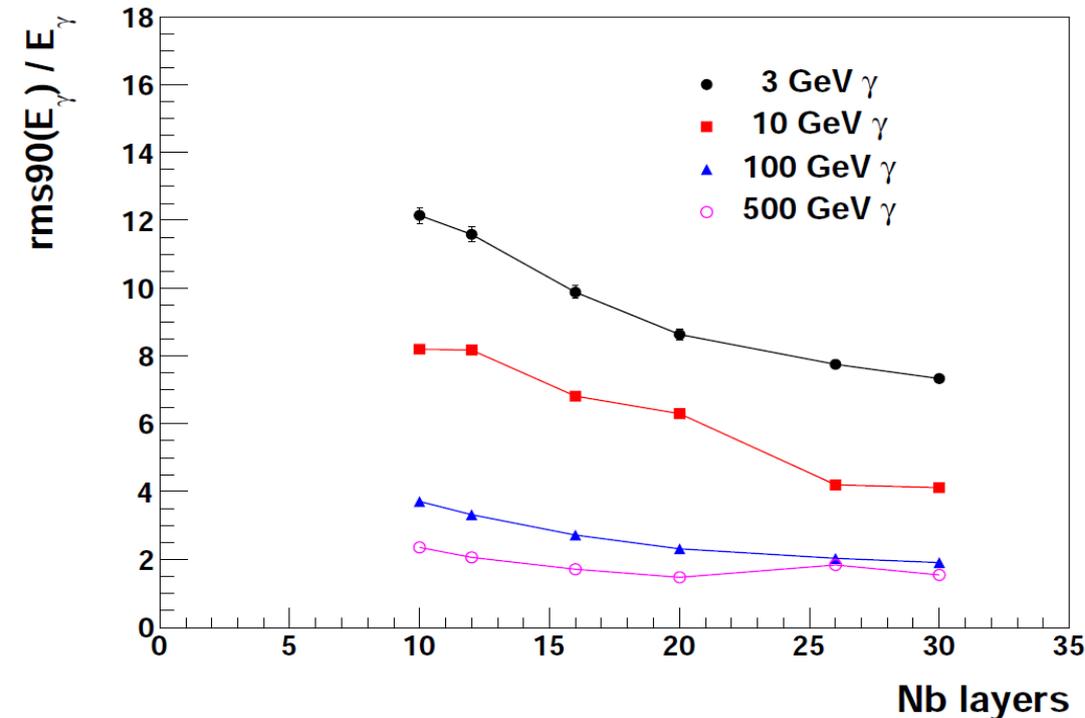
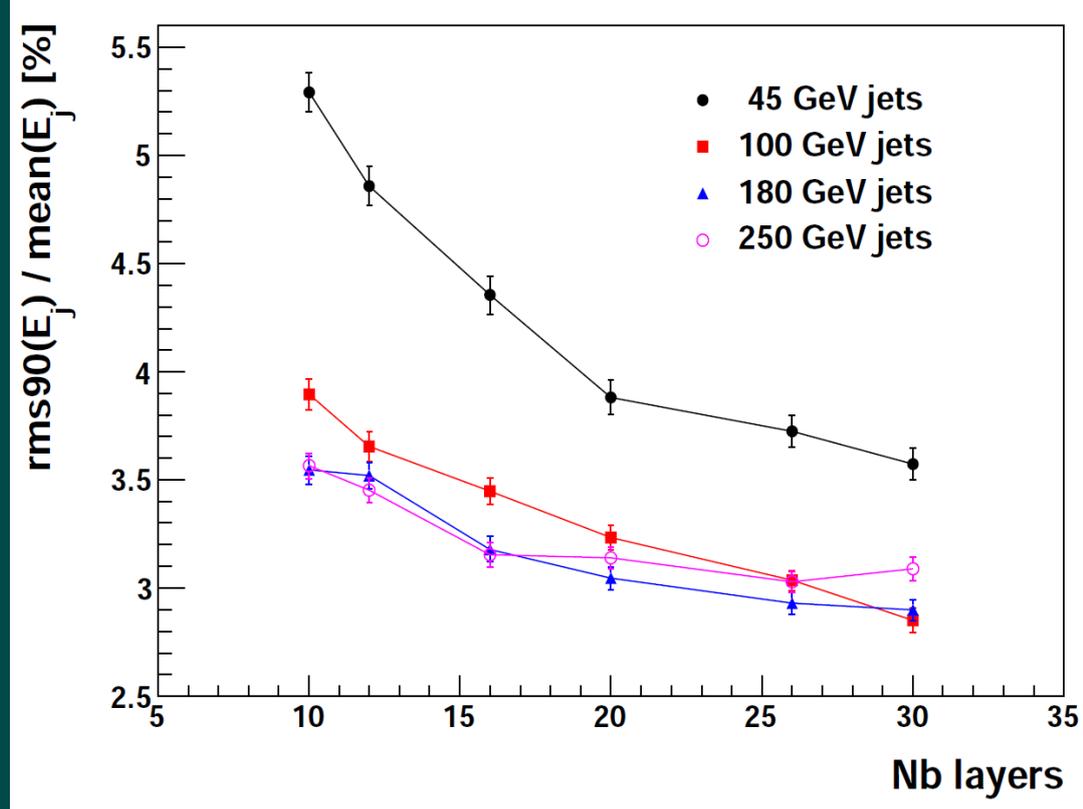
Constant absorber thickness,  
vary number of sampling layers

Effect on photon and  
jet energy resolution

Degrades photon stochastic term  
-> effects lower energy photons and  
lower energy jets

Performance with 20 layers  
may be acceptable

*T H Tran, LLR*



# PCB of Active Sensor Unit (ASU)

18x18 cm<sup>2</sup>, multilayer

Si sensors glued on one side

Host the front end readout ASIC

DAQ, power lines

Minimise thickness

-> reduce Molière radius, total thickness

...but preserve flatness

Technologically challenging

Current prototypes ~1.2 mm: difficult

Optimistic hope ~ 0.8mm: not yet demonstrated

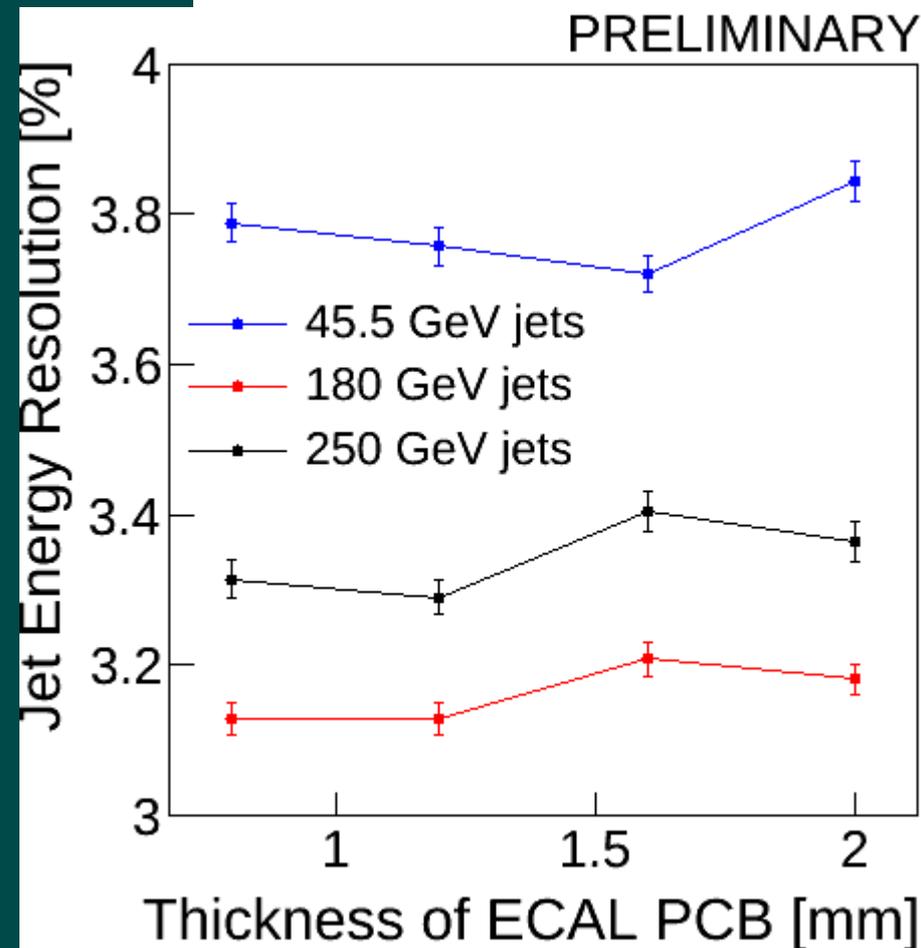
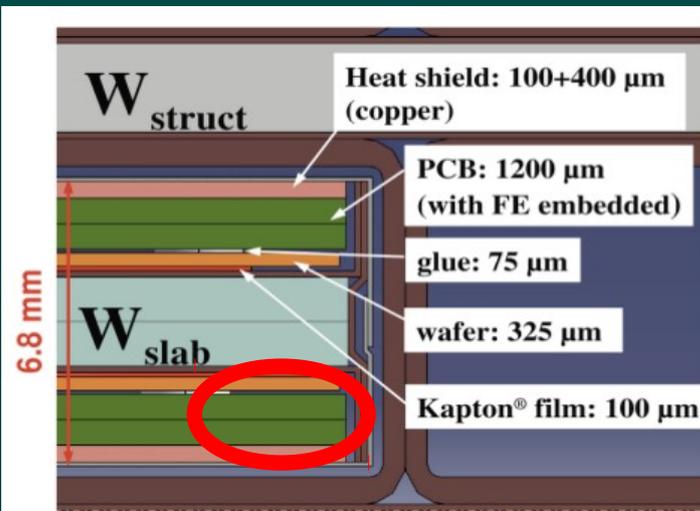
Assess effect of increasing thickness:

JER for different PCB thicknesses

No strong effect on performance

Can relax beyond 1.2 mm

However: has effect on overall ECAL thickness  
and size of HCAL, coil, yoke...

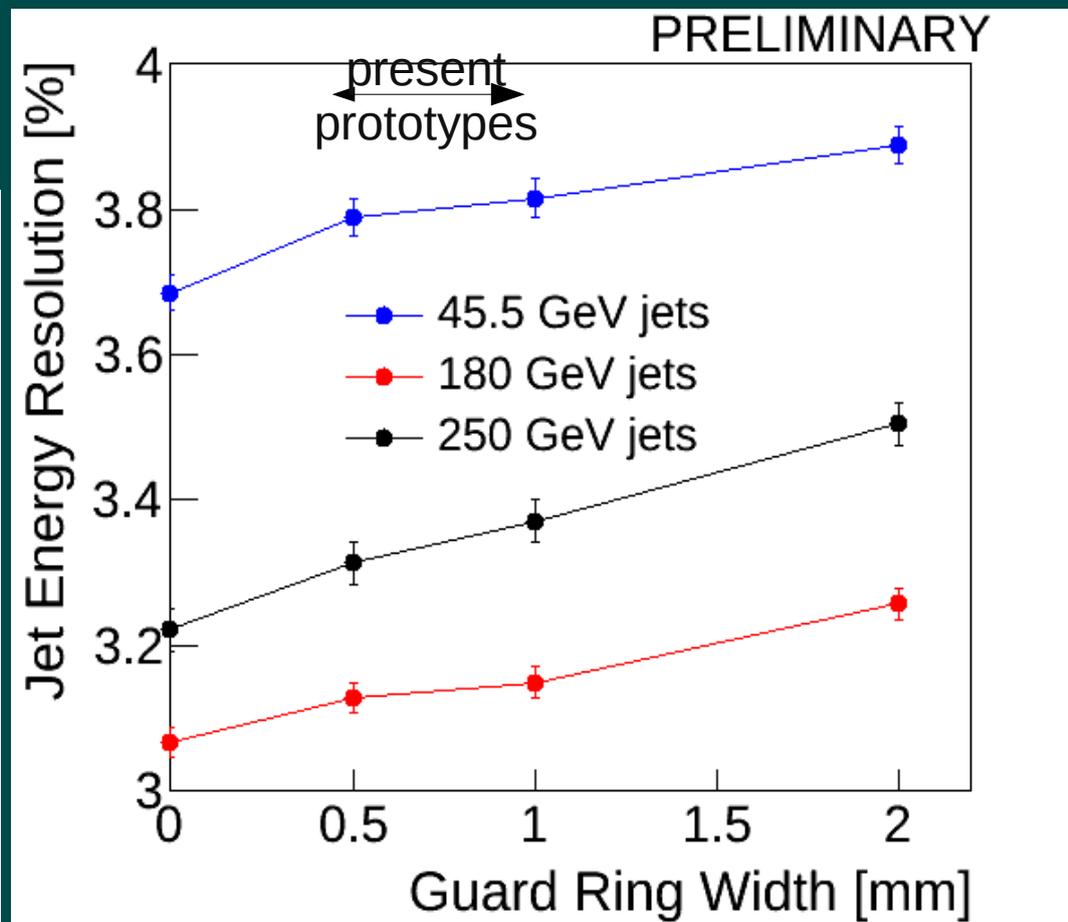
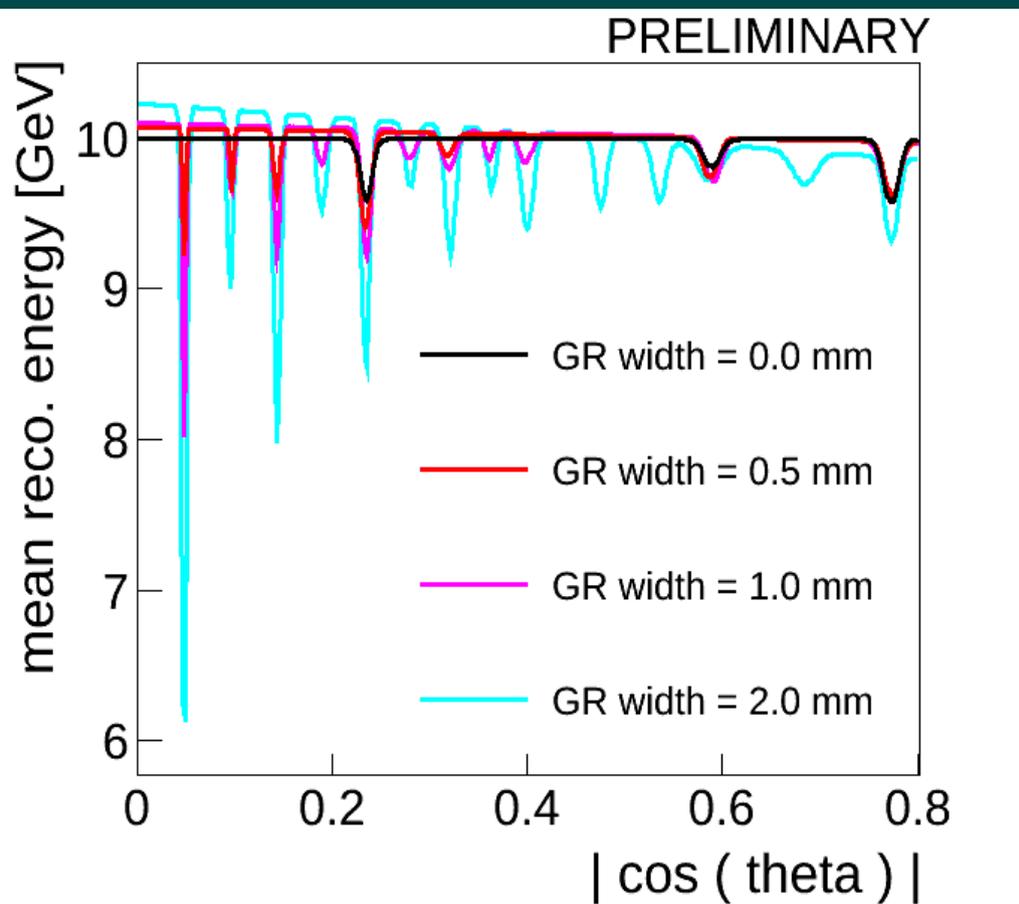


Dead area at edge of silicon sensor  
due to guard ring, mechanical tolerances

Simulation study to understand effects of this region  
How carefully do we need to minimize?

These dead zones are projective only at theta = 90 degrees

Simple average energy correction function



Small (but non-negligible) effect

C Kozakai, Tokyo

# Silicon sensor quality/defects

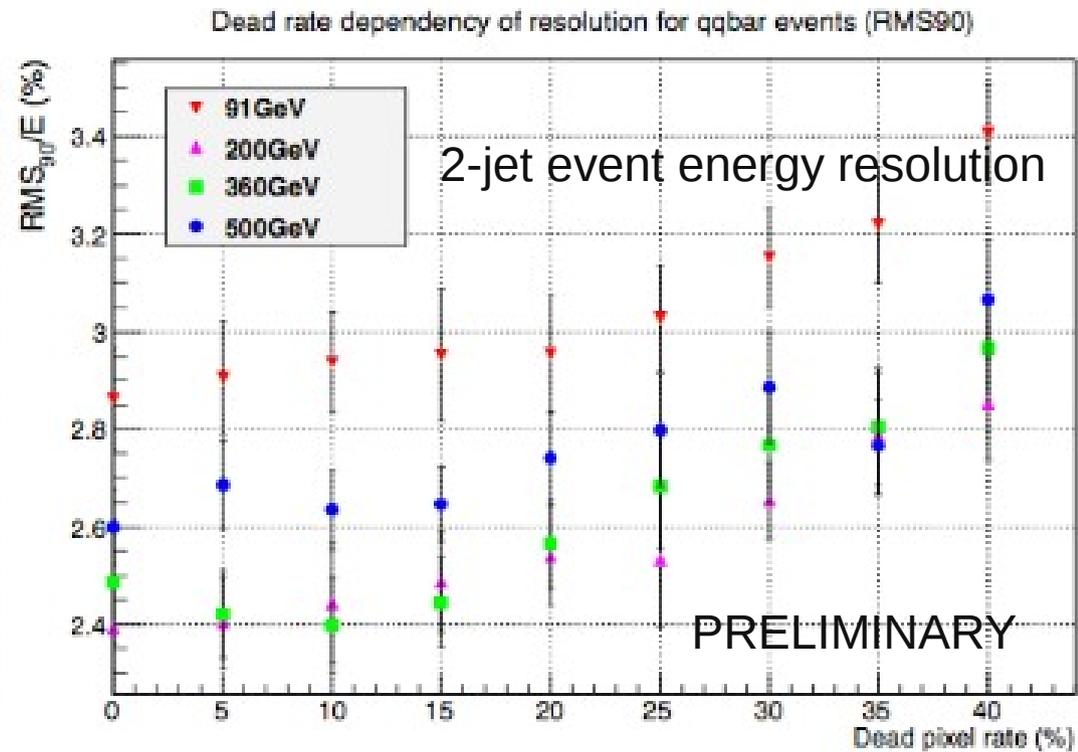
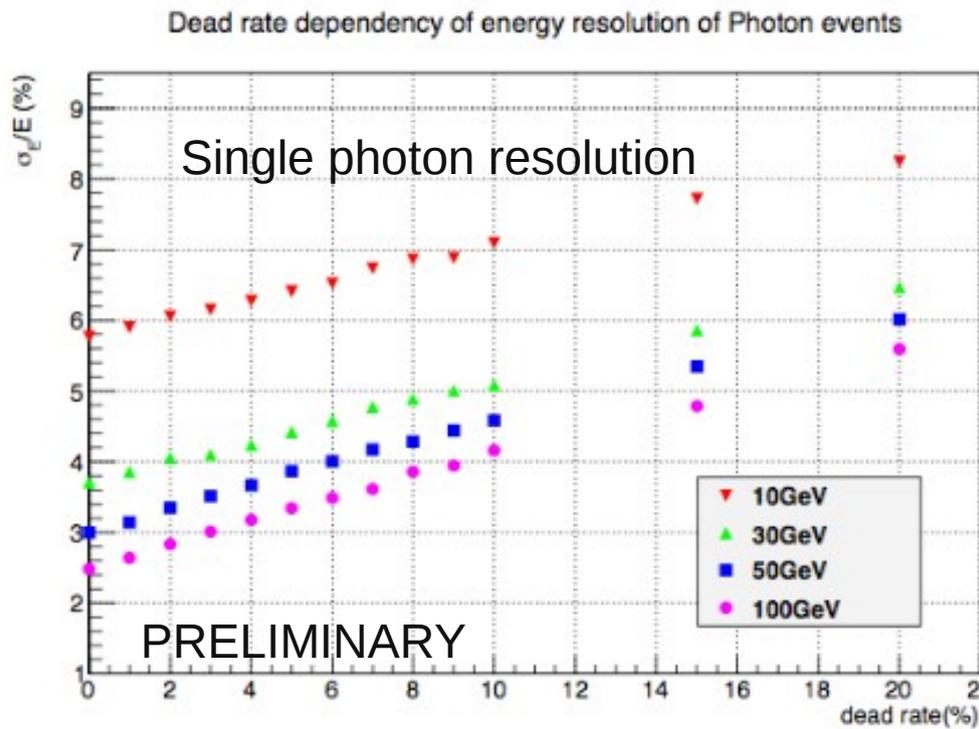
How robust are the ECAL design and PFA reconstruction against sensor imperfections?

Every particle is measured by 10s -> 1000s of detector cells

Are “perfect” sensors required?

Can we accept sensors with a small number of “randomly” distributed defective cells?

Improve industrial yield, reduce cost

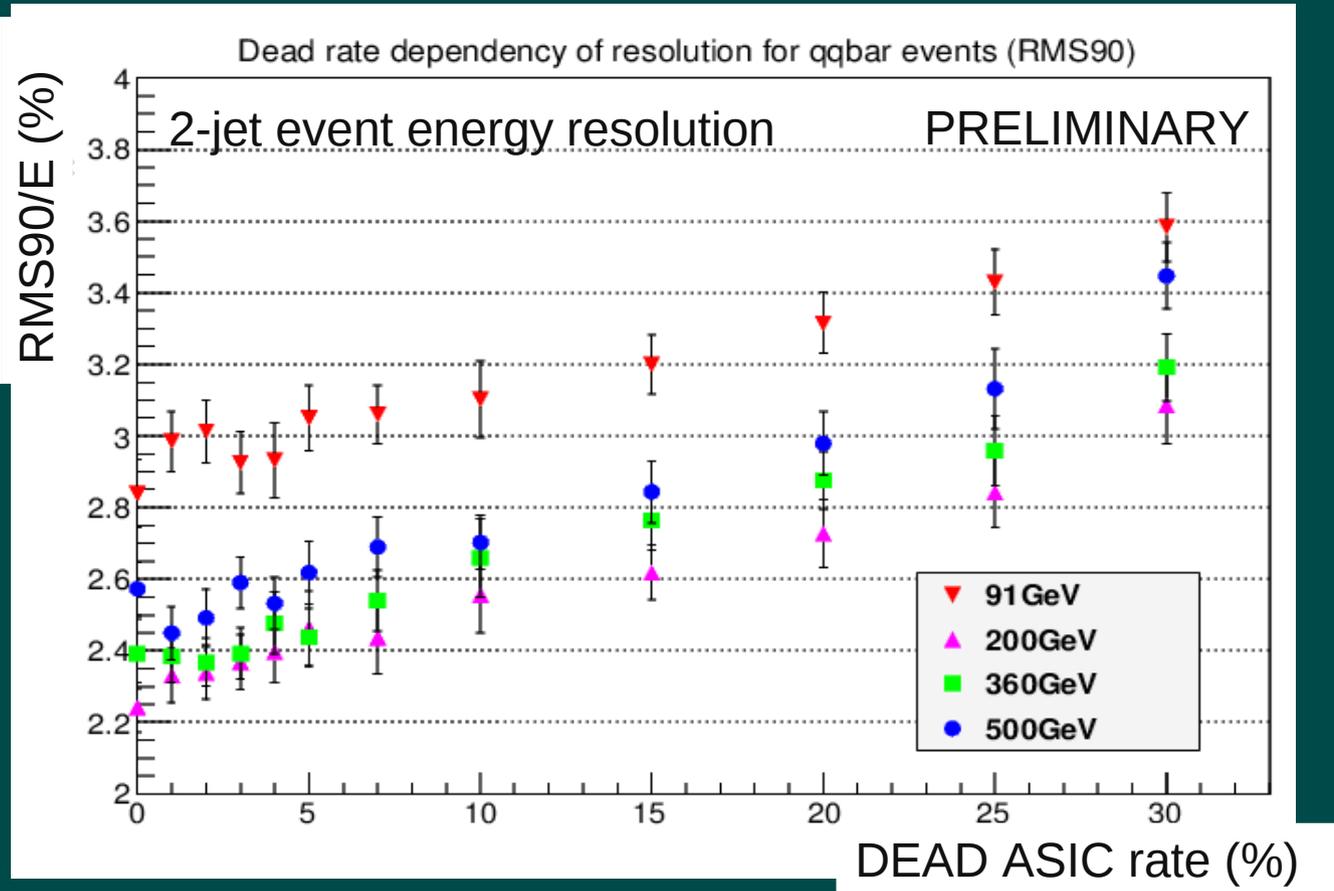


Global correction factor applied  
more sophisticated approaches possible

Negligible effect on Jet measurement,  
even up to ~15%

What if an entire readout ASIC fails ?  
(e.g. bonding failure during assembly)  
Lose block of 64 readout cells  
Do we reject entire ASU?

(1 ASU = 16 ASICS,  
1 ASIC = 64 channels)



Loss of large areas of pixels has more serious effect than random pixels  
A few % is still acceptable  
Expect these to be identified before final assembly  
can be installed in less critical regions of detector (e.g. later layers)

# Summary

Si-W ECAL for ILD  
optimised for Particle Flow reconstruction

3-d readout granularity is central

Compact design based on  
tungsten absorber and  
silicon sensors

Effects of “downgraded” designs to  
ease manufacture, reduce cost  
Number of layers,  
PCB thickness,  
Si sensor dead area

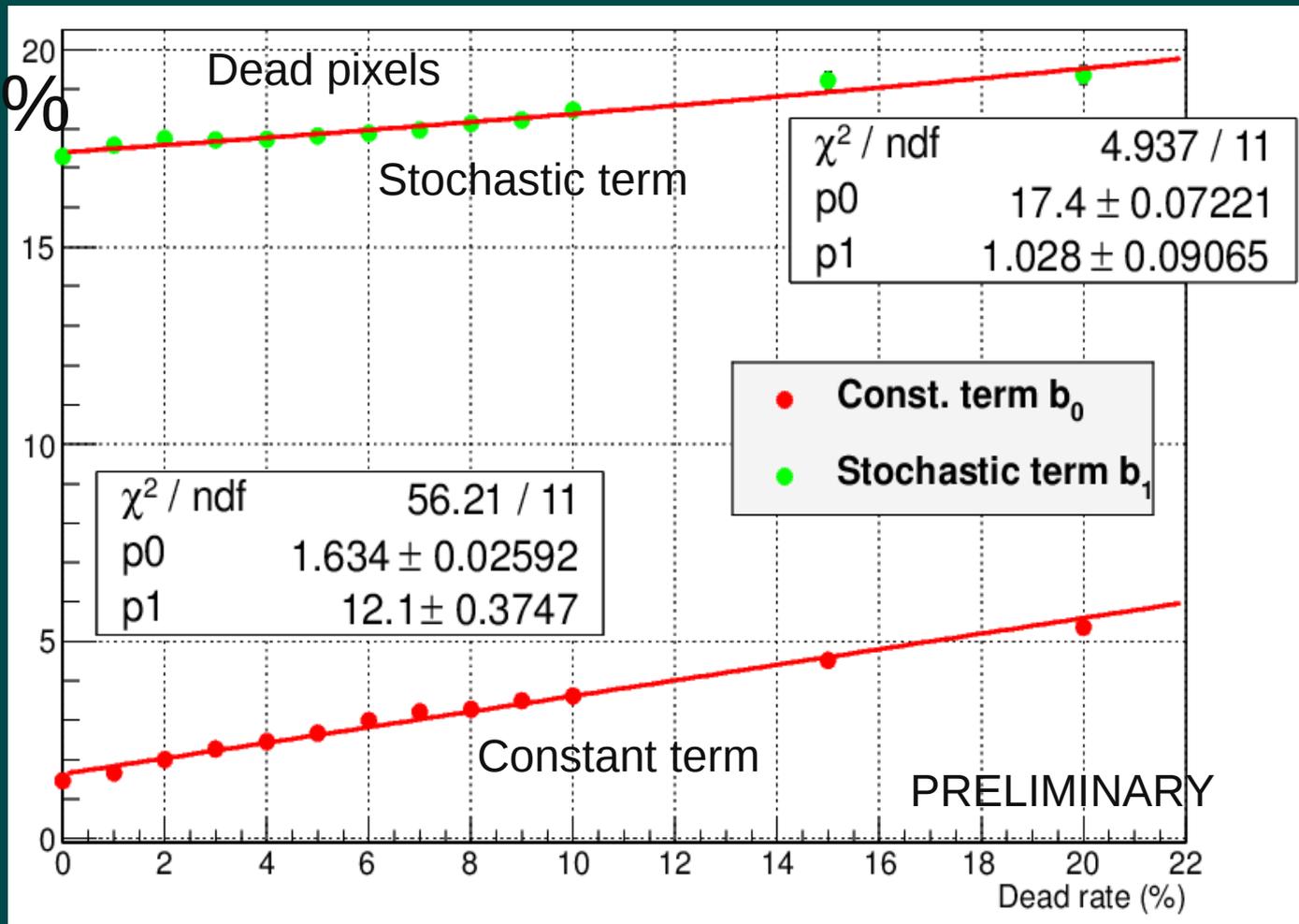
Jet Energy Resolution seems robust against up to  
several % pixel and readout ASIC failures



BACKUP

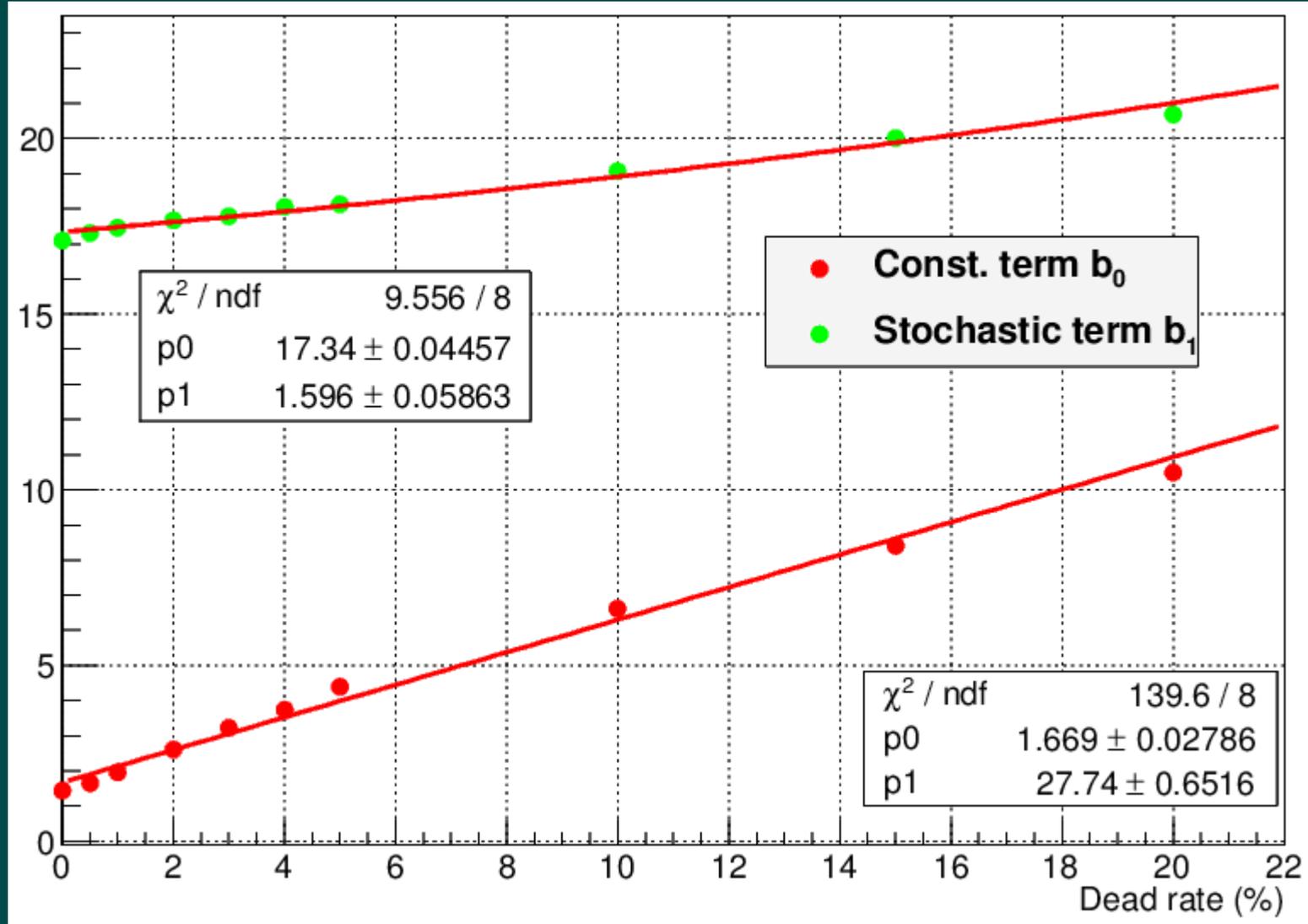
# Dead ECAL pixels for single photon resolution

Constant term, stochastic term

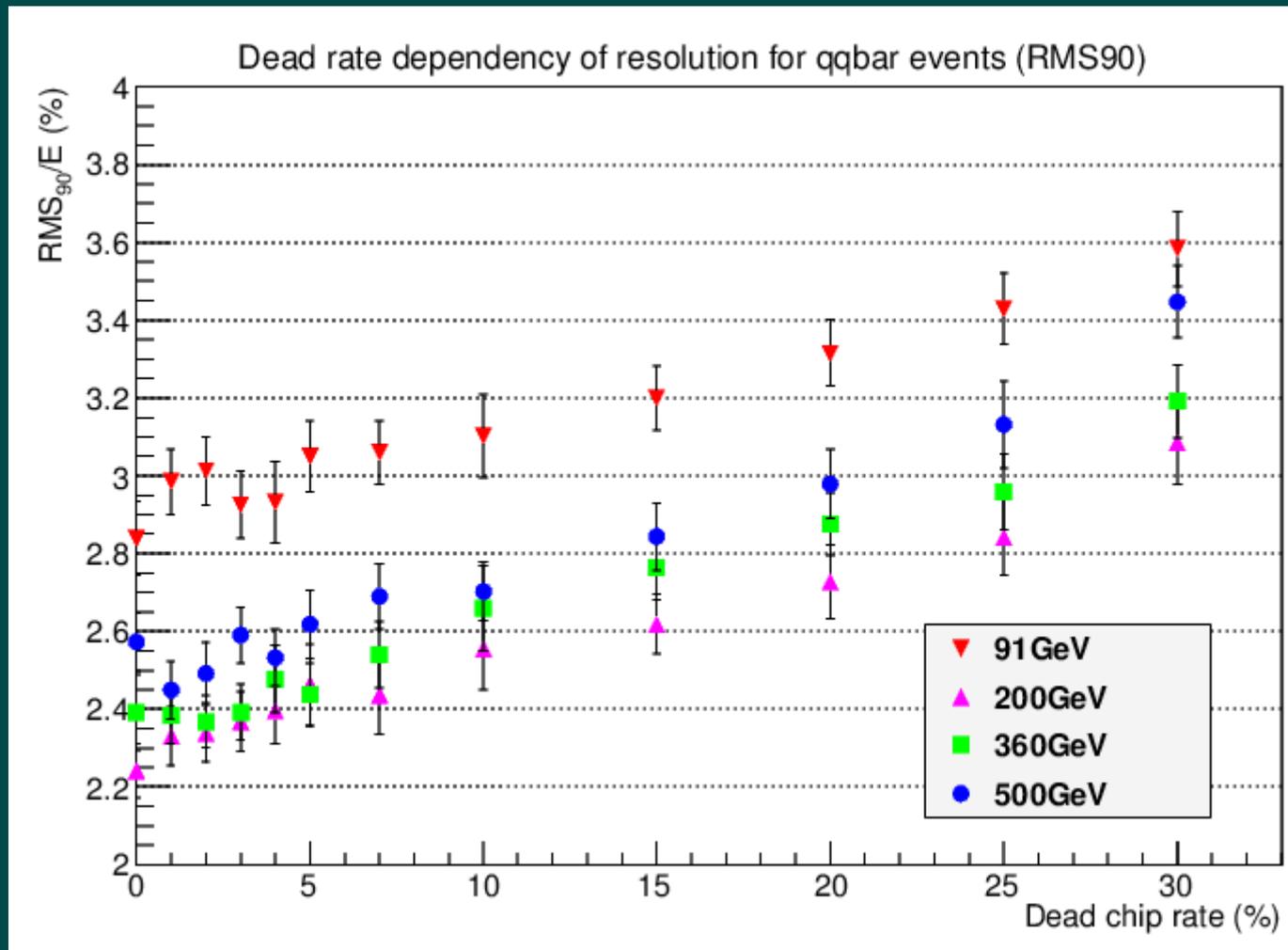


Affects mostly constant term of resolution  
Less important for low energy photons

# Dead ASIC: single photon



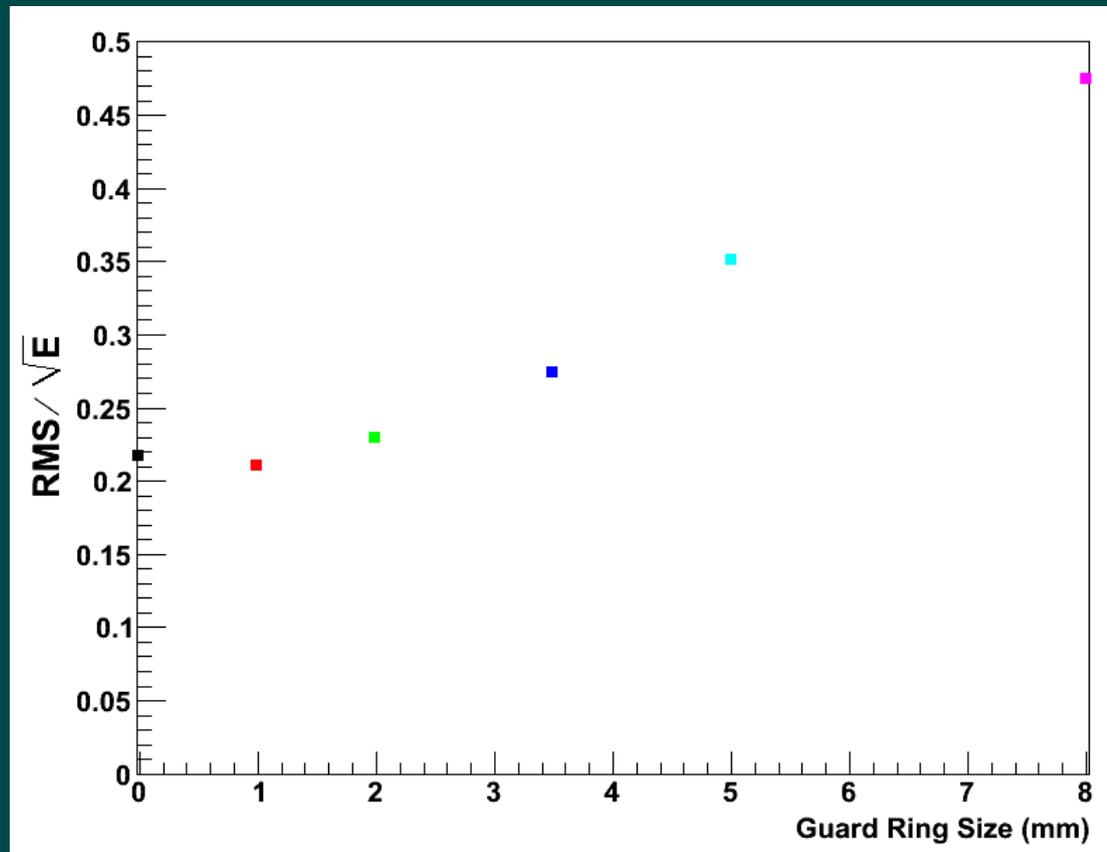
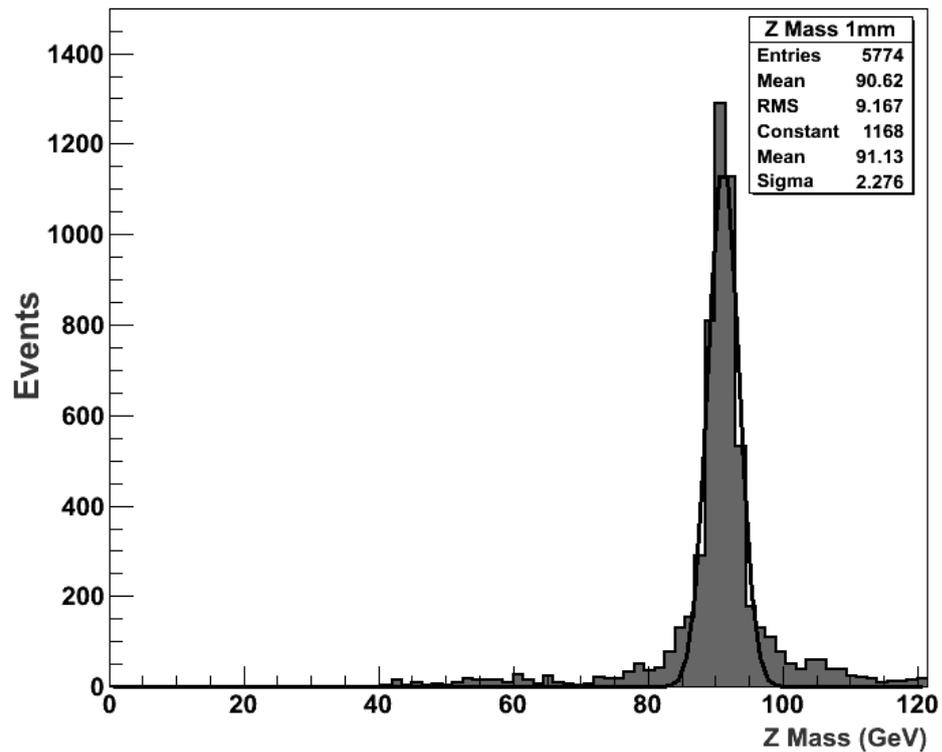
# Dead ASIC: 2-q events



# Effect on Z->ee reconstruction of guard ring width

Reconstruction of Z mass in Z->e+e- important for higgs-strahlung measurement

Could be sensitive to effects of large GR



No significant degradation in realistic GR size range (0->2 mm)

# Calibration

How can you hope to calibrate  $10^8$  detector cells?

PIN diode response expected to be very stable  
seen in test beams over ~5 year period

Electrical characterisation of PIN diodes  
width of depletion layer

Calibrate all ASUs before final assembly  
Sensor + front end ASIC  
Muon beam and/or cosmics  
Relative channel-to-channel calibration

Absolute energy scale  
Completed module(s) in test beam

In-situ monitoring  
MIP-like tracks in jets (hadrons, muons)  
Bhabha,  $Z \rightarrow e^+e^-$ ,  $E/p$